

| General Information |  |
| ---: | :--- |
| Supplier: | KEMET |
| Series: | B45196H |
| Dielectric: | MnO2 Tantalum |
| Style: | SMD Chip |
| Description: | SMD, Molded |
| RoHS: | Yes |
| Termination: | Tin |
| Notes: | Obsolete. Old Part <br> Number [Obsolete] Was <br> B45196H4155M106 |
|  |  |


| Dimensions |  |
| :---: | :---: |
| Footprint | 3216 |
| L | $3.2 \mathrm{~mm}+/-0.2 \mathrm{~mm}$ |
| W | $1.6 \mathrm{~mm}+/-0.2 \mathrm{~mm}$ |
| H | $1.6 \mathrm{~mm}+/-0.2 \mathrm{~mm}$ |
| S | $0.8 \mathrm{~mm}+/-0.3 \mathrm{~mm}$ |
| F | $1.2 \mathrm{~mm}+/-0.1 \mathrm{~mm}$ |
| K | 1.3 mm TYP |


| Specifications |  |
| ---: | :--- |
| Capacitance: | 1.5 uF |
| Capacitance Tolerance: | $20 \%$ |
| Voltage DC: | $20 \mathrm{VDC}(85 \mathrm{C}), 13.4 \mathrm{VDC} \mathrm{(125C)}$ |
| Temperature Range: | $-55 /+125 \mathrm{C}$ |
| Rated Temperature: | 85 C |
| Dissipation Factor: | $6 \%$ |
| Failure Rate: | N/A |
| Leakage Current: | 0.5 uA |


| Packaging Specifications |  |
| ---: | :--- |
| Packaging: | T\&R, 330mm |
| Packaging Quantity: | 9000 |

